onsemi

MOSFET - Power, Single N-Channel, SO8-FL 30 V, 0.52 mΩ, 464 A

NTMFS0D5N03C

Features

- Advanced Package (5x6mm) with Excellent Thermal Conduction
- Ultra Low R_{DS(on)} to Improve System Efficiency
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- ORing
- Motor Drive
- Power Load Switch
- DC–DC Converters
- Battery Management and Protection

MAXIMUM RATINGS (T_J = 25° C unless otherwise stated)

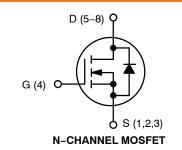
Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	30	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain	Steady	$T_{C} = 25^{\circ}C$	۱ _D	464	А
Current R _{0JC} (Note 2)		T _C =100°C		328	
Power Dissipation $R_{\theta JC}$ (Note 2)	State	T _C = 25°C	P _D	200	W
Continuous Drain		$T_A = 25^{\circ}C$	I _D	65	А
Current R _{θJA} (Notes 1, 2)	Steady	T _A = 100°C		46	
Power Dissipation $R_{\theta JA}$ (Notes 1, 2)	State	$T_A = 25^{\circ}C$	P _D	3.9	W
Pulsed Drain Current	in Current $T_A = 25^{\circ}C$, $t_p = 10 \ \mu s$			900	А
Source Current (Body Diode)			۱ _S	166	А
Single Pulse Drain-to-Source Avalanche Energy ($I_L = 96 A_{pk}$)			E _{AS}	467	mJ
Operating Junction and Storage Temperature Range			T _J , T _{STG}	–55 to +175	°C
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

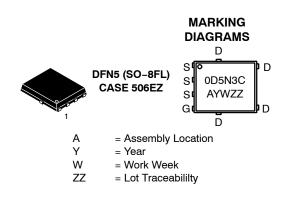
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface-mounted on FR4 board using 1 in² pad, 2 oz Cu pad.

The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
30 V	$0.52~\mathrm{m}\Omega @~10~\mathrm{V}$	464 A
30 V	0.78 mΩ @ 4.5 V	404 A





ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

THERMAL RESISTANCE MAXIMUM RATINGS

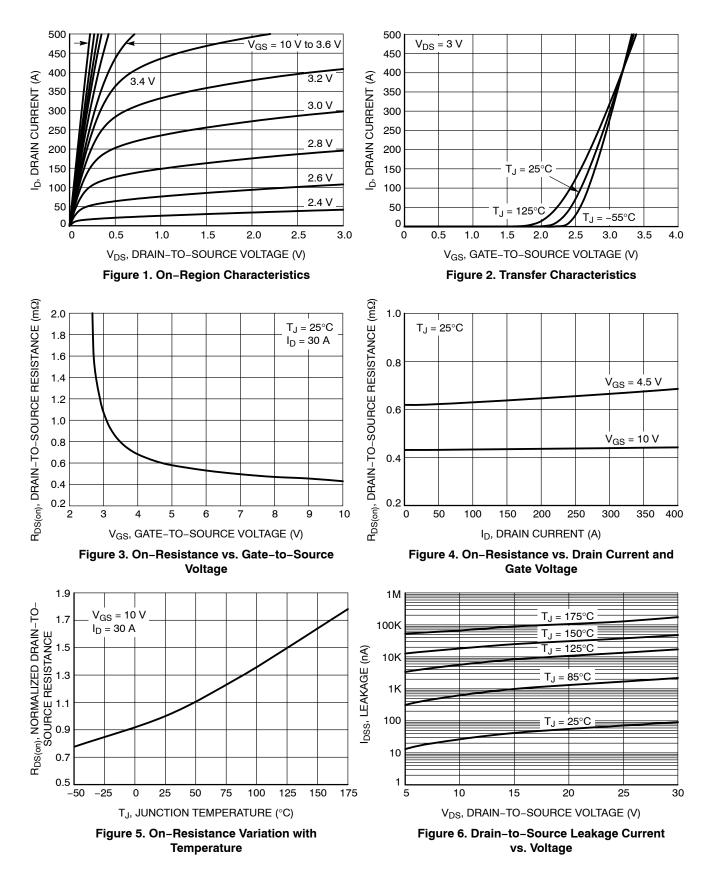
Parameter	Symbol	Value	Unit	
Junction-to-Case - Steady State (Note 1)	$R_{\theta JC}$	0.8	°C/W	
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	38		

ELECTRICAL CHARACTERISTICS (T₁ = 25°C unless otherwise specified)

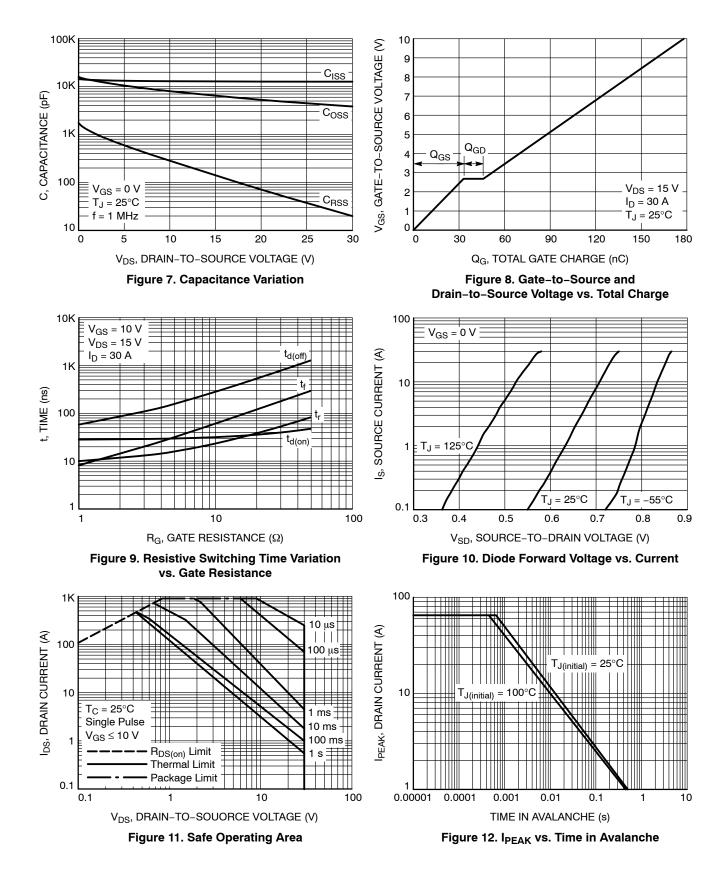
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 µA		30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J	$I_D = 250 \ \mu A. \text{ ref to } 25^{\circ}C$			11		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	DSS $V_{GS} = 0 V$, $T_J = 25^{\circ}C$				1.0	μΑ
	V _{DS} = 30 V	T _J = 125°C			100		
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V				100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 330 μA	1.3		2.2	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J	$I_D = 330 \ \mu A. ref to 25^{\circ}C$			-5.9		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D = 30 A			0.43	0.52	mΩ
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 30 A			0.62	0.78	mΩ
Forward Transconductance	9 _{FS}	V _{DS} = 3 V, I _D = 30 A			208		S
Gate Resistance	R _G	$T_A = 25^{\circ}C$			0.4		Ω
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, V _{DS} = 15 V, f = 1 MHz			13000		pF
Output Capacitance	C _{OSS}				6540		
Reverse Transfer Capacitance	C _{RSS}				146		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 15 V; I _D = 30 A			80		nC
Threshold Gate Charge	Q _{G(TH)}				20		
Gate-to-Drain Charge	Q _{GD}				13		
Gate-to-Source Charge	Q _{GS}				33		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 15 V; I _D = 30 A			178		nC
SWITCHING CHARACTERISTICS (Note 4)							
Turn-On Delay Time	t _{d(ON)}				29		
Rise Time	t _r	V_{GS} = 10 V, V_{DS} = 15 V, I_{D} = 30 A, R_{G} = 3.0 Ω			13		- ns
Turn-Off Delay Time	t _{d(OFF)}				108		
Fall Time	t _f				20		
DRAIN-SOURCE DIODE CHARACTERISTIC	cs			-	<u> </u>		-
Forward Diode Voltage	V _{SD}	D $V_{GS} = 0 V,$ $I_S = 30 A$	$T_J = 25^{\circ}C$		0.75	1.2	- V
			T _J = 125°C		0.58		
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dlS/dt = 100 A/µs, V _{DS} = 15 V, l _S = 30 A			103		ns
•							

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%. 4. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



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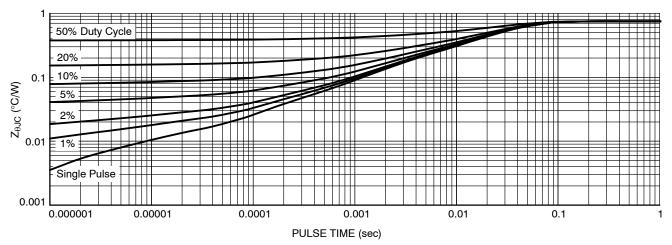


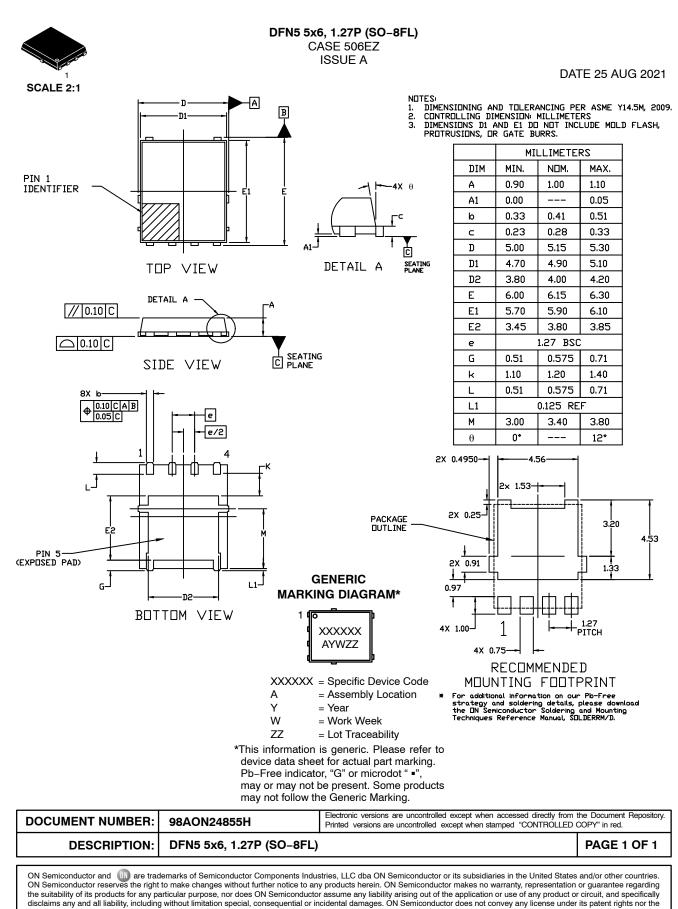
Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NTMFS0D5N03CT1G	0D5N3C	DFN5 (Pb–Free)	1500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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